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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	4848
Number of Logic Elements/Cells	43632
Total RAM Bits	3538944
Number of I/O	416
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp40-5fg676c



Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Introduction and Overview

DS083 (v5.0) June 21, 2011

Product Specification

Summary of Virtex-II Pro™ / Virtex-II Pro X Features

- High-Performance Platform FPGA Solution, Including
 - Up to twenty RocketIO™ or RocketIO X embedded Multi-Gigabit Transceivers (MGTS)
 - Up to two IBM PowerPC™ RISC processor blocks
 - Based on Virtex-II™ Platform FPGA Technology
 - Flexible logic resources
 - SRAM-based in-system configuration
 - Active Interconnect technology
 - SelectRAM™+ memory hierarchy
 - Dedicated 18-bit x 18-bit multiplier blocks
 - High-performance clock management circuitry
 - SelectIO™-Ultra technology
 - XCITE Digitally Controlled Impedance (DCI) I/O
- Virtex-II Pro / Virtex-II Pro X family members and resources are shown in [Table 1](#).

Table 1: Virtex-II Pro / Virtex-II Pro X FPGA Family Members

Device ⁽¹⁾	RocketIO Transceiver Blocks	PowerPC Processor Blocks	Logic Cells ⁽²⁾	CLB (1 = 4 slices = max 128 bits)		18 X 18 Bit Multiplier Blocks	Block SelectRAM+		DCMs	Maximum User I/O Pads
				Slices	Max Distr RAM (Kb)		18 Kb Blocks	Max Block RAM (Kb)		
XC2VP2	4	0	3,168	1,408	44	12	12	216	4	204
XC2VP4	4	1	6,768	3,008	94	28	28	504	4	348
XC2VP7	8	1	11,088	4,928	154	44	44	792	4	396
XC2VP20	8	2	20,880	9,280	290	88	88	1,584	8	564
XC2VPX20	8 ⁽⁴⁾	1	22,032	9,792	306	88	88	1,584	8	552
XC2VP30	8	2	30,816	13,696	428	136	136	2,448	8	644
XC2VP40	0 ⁽³⁾ , 8, or 12	2	43,632	19,392	606	192	192	3,456	8	804
XC2VP50	0 ⁽³⁾ or 16	2	53,136	23,616	738	232	232	4,176	8	852
XC2VP70	16 or 20	2	74,448	33,088	1,034	328	328	5,904	8	996
XC2VPX70	20 ⁽⁴⁾	2	74,448	33,088	1,034	308	308	5,544	8	992
XC2VP100	0 ⁽³⁾ or 20	2	99,216	44,096	1,378	444	444	7,992	12	1,164

Notes:

- 7 speed grade devices are not available in Industrial grade.
- Logic Cell $\approx$ (1) 4-input LUT + (1)FF + Carry Logic
- These devices can be ordered in a configuration without RocketIO transceivers. See [Table 3](#) for package configurations.
- Virtex-II Pro X devices equipped with RocketIO X transceiver cores.

RocketIO X Transceiver Features (XC2VPX20 and XC2VPX70 Only)

- Variable-Speed Full-Duplex Transceiver (XC2VPX20) Allowing 2.488 Gb/s to 6.25 Gb/s Baud Transfer Rates.
 - Includes specific baud rates used by various standards, as listed in [Table 4, Module 2](#).
- Fixed-Speed Full-Duplex Transceiver (XC2VPX70) Operating at 4.25 Gb/s Baud Transfer Rate.
- Eight or Twenty Transceiver Modules on an FPGA, Depending upon Device
- Monolithic Clock Synthesis and Clock Recovery
 - Eliminates the need for external components
- Automatic Lock-to-Reference Function
- Programmable Serial Output Differential Swing
 - 200 mV to 1600 mV, peak-peak
 - Allows compatibility with other serial system voltage levels
- Programmable Pre-emphasis Levels 0 to 500%
- Telecom/Datacom Support Modes
 - "x8" and "x10" clocking/data paths
 - 64B/66B clocking support

ing character, and remembers its location in the buffer. At some point, one transceiver designated as the master instructs all the transceivers to align to the channel bonding character "P" (or to some location relative to the channel bonding character).

After this operation, words transmitted to the FPGA fabric are properly aligned: RRRR, SSSS, TTTT, and so forth, as shown in the bottom-right portion of **Figure 7**. To ensure that the channels remain properly aligned following the channel bonding operation, the master transceiver must also control the clock correction operations described in the previous section for all channel-bonded transceivers.

Transmitter Buffer

The transmitter's buffer write pointer (TXUSRCLK) is frequency-locked to its read pointer (REFCLK). Therefore, clock correction and channel bonding are not required. The purpose of the transmitter's buffer is to accommodate a phase difference between TXUSRCLK and REFCLK. A simple FIFO suffices for this purpose. A FIFO depth of four will permit reliable operation with simple detection of overflow or underflow, which could occur if the clocks are not frequency-locked.

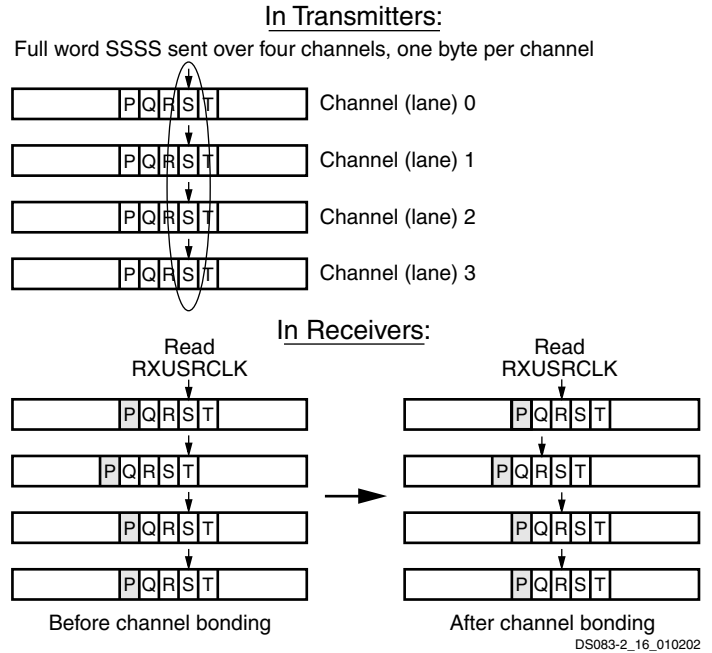


Figure 7: Channel Bonding (Alignment)

RocketIO X Configuration

This section outlines functions that can be selected or controlled by configuration. Xilinx implementation software supports the transceiver primitives shown in **Table 3**.

Table 3: Supported RocketIO X Transceiver Primitives

Primitive	Description
GT10_CUSTOM	Fully customizable by user
GT10_OC48_1	SONET OC-48, 1-byte data path
GT10_OC48_2	SONET OC-48, 2-byte data path
GT10_OC48_4	SONET OC-48, 4-byte data path
GT10_PCI_EXPRESS_1	PCI Express, 1-byte data path
GT10_PCI_EXPRESS_2	PCI Express, 2-byte data path
GT10_PCI_EXPRESS_4	PCI Express, 4-byte data path
GT10_INFINIBAND_1	Infiniband, 1-byte data path
GT10_INFINIBAND_2	Infiniband, 2-byte data path
GT10_INFINIBAND_4	Infiniband, 4-byte data path

CRC may adjust certain trailing bytes to generate the required running disparity at the end of the packet.

On the receiver side, the CRC logic verifies the received CRC value, supporting the same standards as above.

The CRC logic also supports a user mode, with a simple data packet structure beginning and ending with user-defined SOP and EOP characters.

Loopback

In order to facilitate testing without having the need to either apply patterns or measure data at GHz rates, two programmable loop-back features are available.

One option, serial loopback, places the gigabit transceiver into a state where transmit data is directly fed back to the receiver. An important point to note is that the feedback path is at the output pads of the transmitter. This tests the entirety of the transmitter and receiver.

The second option, parallel loopback, checks the digital circuitry. When parallel loopback is enabled, the serial loopback path is disabled. However, the transmitter outputs

remain active, and data can be transmitted. If TXINHIBIT is asserted, TXP is forced to 0 until TXINHIBIT is de-asserted.

Reset

The receiver and transmitter have their own synchronous reset inputs. The transmitter reset recenters the transmission FIFO, and resets all transmitter registers and the 8B/10B decoder. The receiver reset recenters the receiver elastic buffer, and resets all receiver registers and the 8B/10B encoder. Neither reset has any effect on the PLLs.

Power

All RocketIO transceivers in the FPGA, whether instantiated in the design or not, must be connected to power and ground. Unused transceivers can be powered by any 2.5V source, and passive filtering is not required.

Power Down

The Power Down module is controlled by the transceiver's POWERDOWN input pin. The Power Down pin on the FPGA package has no effect on the transceiver.

Figure 36, Figure 37, and Figure 38 illustrate various example configurations.

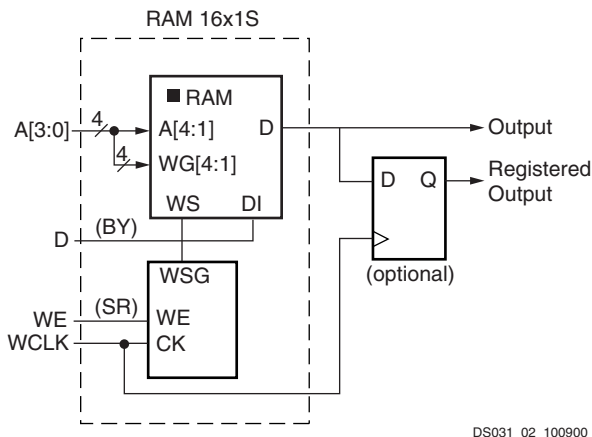


Figure 36: Distributed SelectRAM+ (RAM16x1S)

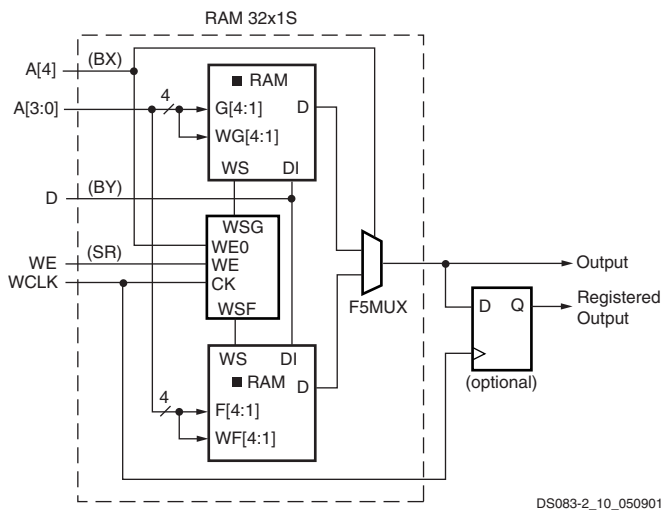


Figure 37: Single-Port Distributed SelectRAM+ (RAM32x1S)

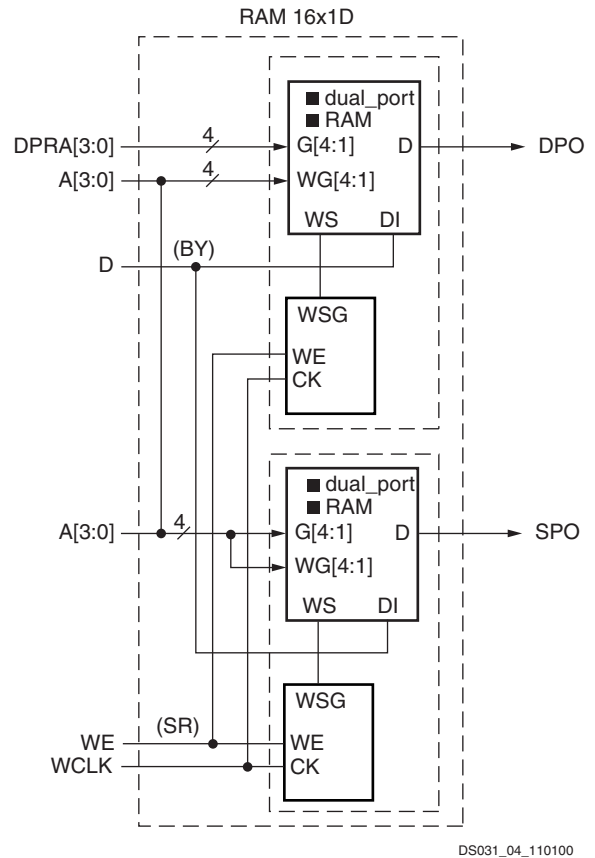


Figure 38: Dual-Port Distributed SelectRAM+ (RAM16x1D)

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 17 shows the number of LUTs occupied by each configuration.

Table 17: ROM Configuration

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Table 34: RocketIO TXUSRCLK2 Switching Characteristics

		Speed Grade			
Description	Symbol	-7	-6	-5	Units
Setup and Hold Relative to Clock (TXUSRCLK2)					
CONFIGENABLE control input	T _{GCKK} _CFGEN/T _{GCKC} _CFGEN	0.35/ 0.10	0.35/ 0.10	0.39/ 0.11	ns, min
TXBYPASS8B10B control inputs	T _{GCKK} _TBYP/T _{GCKC} _TBYP	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
TXFORCECRCERR control input	T _{GCKK} _TCRCE/T _{GCKC} _TCRCE	0.39/ 0.12	0.44/ 0.14	0.49/ 0.15	ns, min
TXPOLARITY control input	T _{GCKK} _TPOL/T _{GCKC} _TPOL	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
TXINHIBIT control inputs	T _{GCKK} _TINH/T _{GCKC} _TINH	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
LOOPBACK control inputs	T _{GCKK} _LBK/T _{GCKC} _LBK	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
TXRESET control input	T _{GCKK} _TRST/T _{GCKC} _TRST	0.02/ 0.10	0.02/ 0.10	0.02/ 0.11	ns, min
TXCHARISK control inputs	T _{GCKK} _TKCH/T _{GCKC} _TKCH	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
TXCHARDISPMODE control inputs	T _{GCKK} _TCDM/T _{GCKC} _TCDM	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
TXCHARDISPVAL control inputs	T _{GCKK} _TCDV/T _{GCKC} _TCDV	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
CONFIGIN data input	T _{GDCK} _CFGIN/T _{GCKD} _CFGIN	0.35/ 0.10	0.35/ 0.10	0.39/ 0.11	ns, min
TXDATA data inputs	T _{GDCK} _TDAT/T _{GCKD} _TDAT	0.02/ 0.00	0.02/ 0.00	0.02/ 0.00	ns, min
Clock to Out					
TXBUFERR status output	T _{GCKST} _TBERR	0.54	0.54	0.60	ns, max
TXKERR status outputs	T _{GCKST} _TKERR	0.41	0.41	0.46	ns, max
TXRUNDISP status outputs	T _{GCKST} _TRDIS	0.41	0.41	0.46	ns, max
CONFIGOUT data output	T _{GCKDO} _CFGOUT	0.25	0.25	0.28	ns, max
Clock					
TXUSRCLK2 minimum pulse width, High	T _{GPWH} _TX2	1.42	1.42	2.25	ns, min
TXUSRCLK2 minimum pulse width, Low	T _{GPWL} _TX2	1.42	1.42	2.25	ns, min

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
7	VCCO_7	G6
N/A	CCLK	N15
N/A	PROG_B	D1
N/A	DONE	P16
N/A	M0	N3
N/A	M1	N2
N/A	M2	P1
N/A	TCK	D16
N/A	TDI	E1
N/A	TDO	E16
N/A	TMS	C16
N/A	PWRDWN_B	N14
N/A	HSWAP_EN	C1
N/A	RSVD	D14
N/A	VBATT	D15
N/A	DXP	D2
N/A	DXN	D3
N/A	AVCCAUXTX6	B5
N/A	VTTXPAD6	B4
N/A	TXNPAD6	A4
N/A	TXPPAD6	A5
N/A	GND A6	C6
N/A	RXPPAD6	A6
N/A	RXNPAD6	A7
N/A	VTRXPAD6	B6
N/A	AVCCAUXRX6	B7
N/A	AVCCAUXTX7	B11
N/A	VTTXPAD7	B10
N/A	TXNPAD7	A10
N/A	TXPPAD7	A11
N/A	GND A7	C11
N/A	RXPPAD7	A12
N/A	RXNPAD7	A13
N/A	VTRXPAD7	B12

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
0	IO_L55N_0	G12			
0	IO_L55P_0	F12			
0	IO_L57N_0	E12			
0	IO_L57P_0/VREF_0	F13			
0	IO_L67N_0	D12			
0	IO_L67P_0	C12			
0	IO_L69N_0	J13			
0	IO_L69P_0/VREF_0	H13			
0	IO_L74N_0/GCLK7P	E13			
0	IO_L74P_0/GCLK6S	D13			
0	IO_L75N_0/GCLK5P	C13			
0	IO_L75P_0/GCLK4S	B13			
1	IO_L75N_1/GCLK3P	B14			
1	IO_L75P_1/GCLK2S	C14			
1	IO_L74N_1/GCLK1P	D14			
1	IO_L74P_1/GCLK0S	E14			
1	IO_L69N_1/VREF_1	H14			
1	IO_L69P_1	J14			
1	IO_L67N_1	C15			
1	IO_L67P_1	D15			
1	IO_L57N_1/VREF_1	F14			
1	IO_L57P_1	E15			
1	IO_L55N_1	F15			
1	IO_L55P_1	G15			
1	IO_L54N_1	H15			
1	IO_L54P_1	J15			
1	IO_L53_1/No_Pair	F16			
1	IO_L50_1/No_Pair	G16			
1	IO_L49N_1	C17			
1	IO_L49P_1	D17			
1	IO_L48N_1	E16			
1	IO_L48P_1	E17			
1	IO_L46N_1	H16			
1	IO_L46P_1	H17			

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
N/A	RXPPAD7		A12			
N/A	RXNPAD7		A11			
N/A	VTRXPAD7		B12			
N/A	AVCCAUXRX7		B11			
N/A	AVCCAUXTX9		B6			
N/A	VTTXPAD9		B7			
N/A	TXNPAD9		A7			
N/A	TXPPAD9		A6			
N/A	GND A9		C6			
N/A	RXPPAD9		A5			
N/A	RXNPAD9		A4			
N/A	VTRXPAD9		B5			
N/A	AVCCAUXRX9		B4			
N/A	AVCCAUXRX16		AJ4			
N/A	VTRXPAD16		AJ5			
N/A	RXNPAD16		AK4			
N/A	RXPPAD16		AK5			
N/A	GND A16		AH6			
N/A	TXPPAD16		AK6			
N/A	TXNPAD16		AK7			
N/A	VTTXPAD16		AJ7			
N/A	AVCCAUXTX16		AJ6			
N/A	AVCCAUXRX18		AJ11			
N/A	VTRXPAD18		AJ12			
N/A	RXNPAD18		AK11			
N/A	RXPPAD18		AK12			
N/A	GND A18		AH12			
N/A	TXPPAD18		AK13			
N/A	TXNPAD18		AK14			
N/A	VTTXPAD18		AJ14			
N/A	AVCCAUXTX18		AJ13			
N/A	AVCCAUXRX19		AJ17			
N/A	VTRXPAD19		AJ18			
N/A	RXNPAD19		AK17			
N/A	RXPPAD19		AK18			
N/A	GND A19		AH19			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
2	IO_L57N_2	R4				
2	IO_L57P_2	R3				
2	IO_L58N_2/VREF_2	R2				
2	IO_L58P_2	T2				
2	IO_L59N_2	T8				
2	IO_L59P_2	T7				
2	IO_L60N_2	T6				
2	IO_L60P_2	T5				
2	IO_L85N_2	T4				
2	IO_L85P_2	T3				
2	IO_L86N_2	U10				
2	IO_L86P_2	U9				
2	IO_L87N_2	U6				
2	IO_L87P_2	U5				
2	IO_L88N_2/VREF_2	U2				
2	IO_L88P_2	V2				
2	IO_L89N_2	U8				
2	IO_L89P_2	U7				
2	IO_L90N_2	U4				
2	IO_L90P_2	U3				
3	IO_L90N_3	V3				
3	IO_L90P_3	V4				
3	IO_L89N_3	V7				
3	IO_L89P_3	V8				
3	IO_L88N_3	V5				
3	IO_L88P_3	V6				
3	IO_L87N_3/VREF_3	W2				
3	IO_L87P_3	Y2				
3	IO_L86N_3	V9				
3	IO_L86P_3	V10				
3	IO_L85N_3	W3				
3	IO_L85P_3	W4				
3	IO_L60N_3	Y1				
3	IO_L60P_3	AA1				
3	IO_L59N_3	V11				
3	IO_L59P_3	W11				
3	IO_L58N_3	W5				

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
7	IO_L51P_7	N31		
7	IO_L51N_7	P31		
7	IO_L50P_7	T27		
7	IO_L50N_7	R28		
7	IO_L49P_7	M33		
7	IO_L49N_7	M34		
7	IO_L48P_7	M31		
7	IO_L48N_7	M32		
7	IO_L47P_7	R24		
7	IO_L47N_7	R25		
7	IO_L46P_7	M29		
7	IO_L46N_7/VREF_7	M30		
7	IO_L45P_7	L33		
7	IO_L45N_7	L34		
7	IO_L44P_7	P27		
7	IO_L44N_7	P28		
7	IO_L43P_7	L29		
7	IO_L43N_7	L30		
7	IO_L42P_7	K33		
7	IO_L42N_7	K34		
7	IO_L41P_7	P26		
7	IO_L41N_7	R26		
7	IO_L40P_7	K32		
7	IO_L40N_7/VREF_7	L32		
7	IO_L39P_7	K29		
7	IO_L39N_7	K30		
7	IO_L38P_7	P24		
7	IO_L38N_7	P25		
7	IO_L37P_7	J32		
7	IO_L37N_7	J33		
7	IO_L36P_7	J31		
7	IO_L36N_7	K31		
7	IO_L35P_7	N28		
7	IO_L35N_7	N29		
7	IO_L34P_7	H32		
7	IO_L34N_7/VREF_7	H33		
7	IO_L33P_7	H29		
7	IO_L33N_7	H30		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
4	VCCO_4	AD12		
4	VCCO_4	AL11		
4	VCCO_4	AG11		
3	VCCO_3	AB12		
3	VCCO_3	AA12		
3	VCCO_3	Y12		
3	VCCO_3	W12		
3	VCCO_3	V12		
3	VCCO_3	AC11		
3	VCCO_3	AF9		
3	VCCO_3	AM8		
3	VCCO_3	AH8		
3	VCCO_3	AD8		
3	VCCO_3	Y8		
3	VCCO_3	AM4		
3	VCCO_3	AH4		
3	VCCO_3	AD4		
3	VCCO_3	Y4		
3	VCCO_3	AK2		
2	VCCO_2	U12		
2	VCCO_2	T12		
2	VCCO_2	R12		
2	VCCO_2	P12		
2	VCCO_2	N12		
2	VCCO_2	M11		
2	VCCO_2	J9		
2	VCCO_2	R8		
2	VCCO_2	L8		
2	VCCO_2	G8		
2	VCCO_2	C8		
2	VCCO_2	R4		
2	VCCO_2	L4		
2	VCCO_2	G4		
2	VCCO_2	C4		
2	VCCO_2	E2		
1	VCCO_1	M17		
1	VCCO_1	M16		
1	VCCO_1	M15		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
1	VCCO_1	H15		
1	VCCO_1	D15		
1	VCCO_1	M14		
1	VCCO_1	M13		
1	VCCO_1	L12		
1	VCCO_1	H11		
1	VCCO_1	D11		
0	VCCO_0	H24		
0	VCCO_0	D24		
0	VCCO_0	L23		
0	VCCO_0	M22		
0	VCCO_0	M21		
0	VCCO_0	M20		
0	VCCO_0	H20		
0	VCCO_0	D20		
0	VCCO_0	M19		
0	VCCO_0	M18		
N/A	CCLK	AG9		
N/A	PROG_B	G26		
N/A	DONE	AF10		
N/A	M0	AG25		
N/A	M1	AG26		
N/A	M2	AF25		
N/A	TCK	G9		
N/A	TDI	F26		
N/A	TDO	F9		
N/A	TMS	H10		
N/A	PWRDWN_B	AG10		
N/A	HSWAP_EN	H25		
N/A	RSVD	H9		
N/A	VBATT	J10		
N/A	DXP	J25		
N/A	DXN	H26		
N/A	VCCINT	AD24		
N/A	VCCINT	L24		
N/A	VCCINT	AC23		

FF1148 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

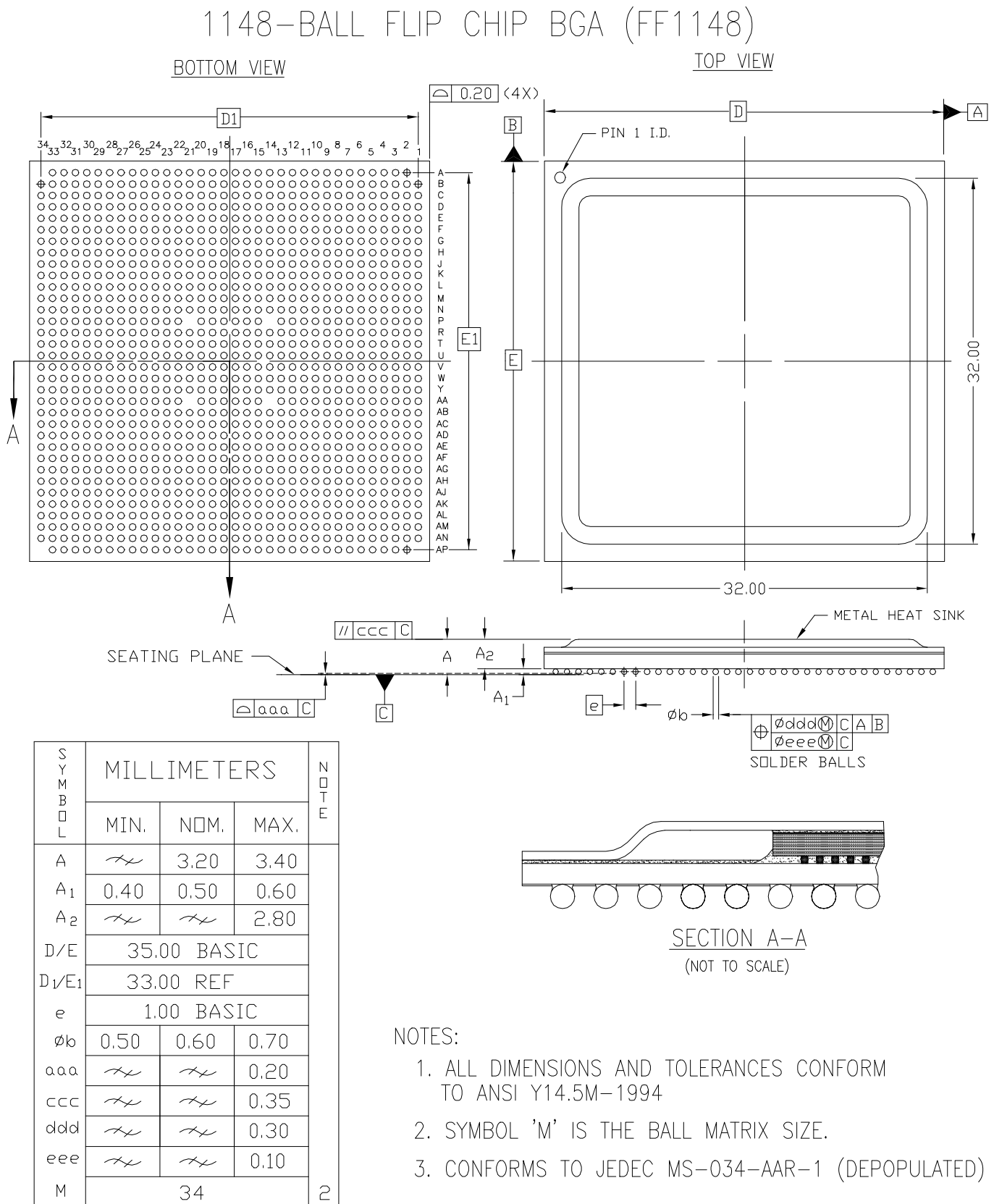


Figure 7: FF1148 Flip-Chip Fine-Pitch BGA Package Specifications

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
0	IO_L34P_0	E27	NC	
0	IO_L35N_0	L26	NC	
0	IO_L35P_0	L25	NC	
0	IO_L36N_0	G26	NC	
0	IO_L36P_0/VREF_0	H26	NC	
0	IO_L37N_0	E26		
0	IO_L37P_0	F26		
0	IO_L38N_0	K25		
0	IO_L38P_0	K24		
0	IO_L39N_0	C26		
0	IO_L39P_0	D26		
0	IO_L43N_0	H25		
0	IO_L43P_0	J25		
0	IO_L44N_0	M25		
0	IO_L44P_0	M24		
0	IO_L45N_0	F25		
0	IO_L45P_0/VREF_0	G25		
0	IO_L46N_0	C25		
0	IO_L46P_0	D25		
0	IO_L47N_0	L23		
0	IO_L47P_0	M22		
0	IO_L48N_0	H24		
0	IO_L48P_0	J24		
0	IO_L49N_0	E25		
0	IO_L49P_0	E24		
0	IO_L50_0/No_Pair	N23		
0	IO_L53_0/No_Pair	M23		
0	IO_L54N_0	H23		
0	IO_L54P_0	J23		
0	IO_L55N_0	F24		
0	IO_L55P_0	G23		
0	IO_L56N_0	K22		
0	IO_L56P_0	L22		
0	IO_L57N_0	C23		
0	IO_L57P_0/VREF_0	D23		
0	IO_L58N_0	H22		
0	IO_L58P_0	J22		
0	IO_L59N_0	N22		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
1	IO_L64N_1	E18		
1	IO_L64P_1	D18		
1	IO_L60N_1	G18		
1	IO_L60P_1	F18		
1	IO_L59N_1	L18		
1	IO_L59P_1	K18		
1	IO_L58N_1	J18		
1	IO_L58P_1	H18		
1	IO_L57N_1/VREF_1	D17		
1	IO_L57P_1	C17		
1	IO_L56N_1	N18		
1	IO_L56P_1	M18		
1	IO_L55N_1	E17		
1	IO_L55P_1	E16		
1	IO_L54N_1	G17		
1	IO_L54P_1	F16		
1	IO_L53_1/No_Pair	J17		
1	IO_L50_1/No_Pair	H17		
1	IO_L49N_1	J16		
1	IO_L49P_1	H16		
1	IO_L48N_1	D15		
1	IO_L48P_1	C15		
1	IO_L47N_1	L17		
1	IO_L47P_1	K16		
1	IO_L46N_1	F15		
1	IO_L46P_1	E15		
1	IO_L45N_1/VREF_1	H15		
1	IO_L45P_1	G15		
1	IO_L44N_1	N17		
1	IO_L44P_1	M17		
1	IO_L43N_1	D14		
1	IO_L43P_1	C14		
1	IO_L39N_1	F14		
1	IO_L39P_1	E14		
1	IO_L38N_1	M16		
1	IO_L38P_1	M15		
1	IO_L37N_1	H14		
1	IO_L37P_1	G14		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L09P_3	AM3		
3	IO_L08N_3	AK8		
3	IO_L08P_3	AK9		
3	IO_L07N_3	AN6		
3	IO_L07P_3	AN7		
3	IO_L84N_3	AN3	NC	
3	IO_L84P_3	AN4	NC	
3	IO_L82N_3	AN1	NC	
3	IO_L82P_3	AN2	NC	
3	IO_L81N_3/VREF_3	AN5	NC	
3	IO_L81P_3	AP5	NC	
3	IO_L79N_3	AP3	NC	
3	IO_L79P_3	AP4	NC	
3	IO_L78N_3	AP1	NC	
3	IO_L78P_3	AP2	NC	
3	IO_L76N_3	AR2	NC	
3	IO_L76P_3	AR3	NC	
3	IO_L75N_3/VREF_3	AT1	NC	
3	IO_L75P_3	AT2	NC	
3	IO_L73N_3	AT5	NC	
3	IO_L73P_3	AU5	NC	
3	IO_L06N_3	AR6		
3	IO_L06P_3	AT6		
3	IO_L05N_3	AL9		
3	IO_L05P_3	AM8		
3	IO_L04N_3	AP7		
3	IO_L04P_3	AR7		
3	IO_L03N_3/VREF_3	AM9		
3	IO_L03P_3	AN9		
3	IO_L02N_3	AR8		
3	IO_L02P_3	AT8		
3	IO_L01N_3/VRP_3	AT7		
3	IO_L01P_3/VRN_3	AU7		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AT9		
4	IO_L01P_4/INIT_B	AR9		
4	IO_L02N_4/D0/DIN ⁽¹⁾	AK11		
4	IO_L02P_4/D1	AK12		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
3	IO_L17N_3		AL9		
3	IO_L17P_3		AL10		
3	IO_L16N_3		AM1		
3	IO_L16P_3		AM2		
3	IO_L15N_3/VREF_3		AM3		
3	IO_L15P_3		AN3		
3	IO_L14N_3		AM8		
3	IO_L14P_3		AM9		
3	IO_L13N_3		AM4		
3	IO_L13P_3		AM5		
3	IO_L12N_3		AM6		
3	IO_L12P_3		AM7		
3	IO_L11N_3		AN9		
3	IO_L11P_3		AM10		
3	IO_L10N_3		AN1		
3	IO_L10P_3		AN2		
3	IO_L09N_3/VREF_3		AN5		
3	IO_L09P_3		AN6		
3	IO_L08N_3		AN7		
3	IO_L08P_3		AN8		
3	IO_L07N_3		AP1		
3	IO_L07P_3		AP2		
3	IO_L84N_3		AP4		
3	IO_L84P_3		AP5		
3	IO_L83N_3		AR7		
3	IO_L83P_3		AP8		
3	IO_L82N_3		AP6		
3	IO_L82P_3		AP7		
3	IO_L81N_3/VREF_3		AR2		
3	IO_L81P_3		AR3		
3	IO_L80N_3		AT5		
3	IO_L80P_3		AR6		
3	IO_L79N_3		AR4		
3	IO_L79P_3		AR5		
3	IO_L78N_3		AT1		
3	IO_L78P_3		AT2		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
5	IO_L19P_5		AV32		
5	IO_L09N_5/VREF_5		AP32		
5	IO_L09P_5		AR32		
5	IO_L08N_5		AW33		
5	IO_L08P_5		AV33		
5	IO_L07N_5/VREF_5		AT33		
5	IO_L07P_5		AU33		
5	IO_L06N_5/VRP_5		AP33		
5	IO_L06P_5/VRN_5		AR33		
5	IO_L05_5/No_Pair		AN32		
5	IO_L03N_5/D4		AW34		
5	IO_L03P_5/D5		AY34		
5	IO_L02N_5/D6		AV34		
5	IO_L02P_5/D7		AU34		
5	IO_L01N_5/RDWR_B		AR34		
5	IO_L01P_5/CS_B		AT34		
6	IO_L01P_6/VRN_6		AW37		
6	IO_L01N_6/VRP_6		AV37		
6	IO_L02P_6		AW36		
6	IO_L02N_6		AV36		
6	IO_L03P_6		AY37		
6	IO_L03N_6/VREF_6		AY38		
6	IO_L04P_6		AU36		
6	IO_L04N_6		AT37		
6	IO_L05P_6		AU35		
6	IO_L05N_6		AT35		
6	IO_L06P_6		AW41		
6	IO_L06N_6		AW42		
6	IO_L73P_6		AV41		
6	IO_L73N_6		AV42		
6	IO_L74P_6		AW40		
6	IO_L74N_6		AV40		
6	IO_L75P_6		AU39		
6	IO_L75N_6/VREF_6		AU40		
6	IO_L76P_6		AU41		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L57P_1	E19	
1	IO_L56N_1	K18	
1	IO_L56P_1	J18	
1	IO_L55N_1	H19	
1	IO_L55P_1	H20	
1	IO_L54N_1	B18	
1	IO_L54P_1	A18	
1	IO_L53_1/No_Pair	L18	
1	IO_L50_1/No_Pair	L19	
1	IO_L49N_1	C18	
1	IO_L49P_1	C19	
1	IO_L48N_1	F18	
1	IO_L48P_1	E18	
1	IO_L47N_1	L17	
1	IO_L47P_1	K17	
1	IO_L46N_1	G18	
1	IO_L46P_1	G19	
1	IO_L18N_1/VREF_1	C17	NC
1	IO_L18P_1	B17	NC
1	IO_L12N_1	G17	NC
1	IO_L12P_1	F17	NC
1	IO_L11N_1	M17	NC
1	IO_L11P_1	M18	NC
1	IO_L10N_1	B16	NC
1	IO_L10P_1	A16	NC
1	IO_L45N_1/VREF_1	D16	
1	IO_L45P_1	D17	
1	IO_L44N_1	K16	
1	IO_L44P_1	J16	
1	IO_L43N_1	F16	
1	IO_L43P_1	E16	
1	IO_L39N_1	H16	
1	IO_L39P_1	H17	
1	IO_L38N_1	M16	
1	IO_L38P_1	L16	
1	IO_L37N_1	B15	
1	IO_L37P_1	A15	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L21P_1	H13	
1	IO_L20N_1	L12	
1	IO_L20P_1	K12	
1	IO_L19N_1	B11	
1	IO_L19P_1	A11	
1	IO_L09N_1/VREF_1	E11	
1	IO_L09P_1	D11	
1	IO_L08N_1	J11	
1	IO_L08P_1	H11	
1	IO_L07N_1	G11	
1	IO_L07P_1	F11	
1	IO_L06N_1	B10	
1	IO_L06P_1	A10	
1	IO_L05_1/No_Pair	G10	
1	IO_L03N_1/VREF_1	C10	
1	IO_L03P_1	C11	
1	IO_L02N_1	L11	
1	IO_L02P_1	K11	
1	IO_L01N_1/VRP_1	F10	
1	IO_L01P_1/VRN_1	E10	
2	IO_L01N_2/VRP_2	B8	
2	IO_L01P_2/VRN_2	A8	
2	IO_L02N_2	C9	
2	IO_L02P_2	B9	
2	IO_L03N_2	B7	
2	IO_L03P_2	A7	
2	IO_L04N_2/VREF_2	B6	
2	IO_L04P_2	A6	
2	IO_L05N_2	D8	
2	IO_L05P_2	D9	
2	IO_L06N_2	B4	
2	IO_L06P_2	A4	
2	IO_L73N_2	C7	
2	IO_L73P_2	C8	
2	IO_L74N_2	G9	
2	IO_L74P_2	F9	